



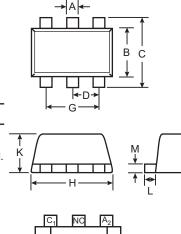
SURFACE MOUNT SCHOTTKY BARRIER DIODE ARRAYS

Features

- Low Forward Voltage Drop
- Fast Switching
- Ultra-Small Surface Mount Package
- PN Junction Guard Ring for Transient and ESD Protection
- Lead Free By Design/RoHS Compliant (Note 1)
- "Green Device" (Note 2)

Mechanical Data

- Case: SOT-563, Molded Plastic
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture sensitivity: Level 1 per J-STD-020C
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin annealed over Alloy 42 leadframe. Solderable per MIL-STD-202, Method 208
- Marking & Type Code Information: See Last Page
- Ordering Information: See Last Page
- Weight: 0.003 grams (approx.)



SOT-563				
Dim	Min Max Typ			
Α	0.15	0.30	0.25	
В	1.10	1.25	1.20	
С	1.55	1.70	1.60	
D	0.50			
G	0.90	1.10	1.00	
Н	1.50	1.70	1.60	
К	0.56	0.60	0.60	
L	0.10	0.30	0.20	
М	0.10	0.18	0.11	
All Dimensions in mm				

Maximum Ratings @ $T_A = 25^{\circ}C$ unless otherwise specified

Characteristic		Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	30	V
Forward Continuous Current (Note 3)		lF	200	mA
Repetitive Peak Forward Current (Note 3)		I _{FRM}	300	mA
Forward Surge Current (Note 3)	@ t < 1.0s	I _{FSM}	600	mA

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 3)	Pd	150	mW
Thermal Resistance, Junction to Ambient Air (Note 3)	$R_{ ext{ heta}JA}$	833	°C/W
Operating and Storage Temperature Range	Tj, T _{STG}	-65 to +125	°C

Electrical Characteristics @ T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Мах	Unit	Test Condition
Reverse Breakdown Voltage (Note 4)	V _{(BR)R}	30			V	I _R = 100μA
Forward Voltage	VF			240 320 400 500 1000	mV	
Reverse Leakage Current (Note 4)	IR			2.0	μA	V _R = 25V
Total Capacitance	CT	_		10	pF	V _R = 1.0V, f = 1.0MHz
Reverse Recovery Time	t _{rr}			5.0	ns	$I_F = 10mA$ through $I_R = 10mA$ to $I_R = 1.0mA$, $R_L = 100\Omega$

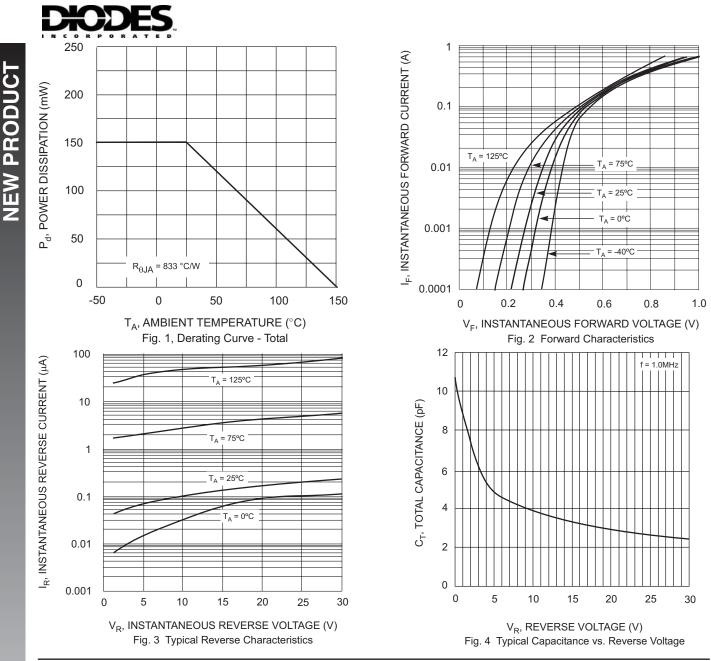
1. No purposefully added lead.

2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.

Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf. T_A = 25°C.

4. Short duration test pulse used to minimize self-heating effect.

Notes:

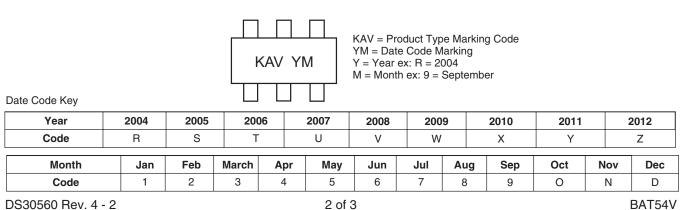


Ordering Information (Note 5)

Device	Packaging	Shipping
BAT54V-7	SOT-563	3000/Tape & Reel

Notes: 5. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



www.diodes.com



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